

CTH Series Capacitive Touch Sensor Display 15.0 x 15.0 x 11.0 mm



CTHS15CIC07 - Yellow Capacitive Touch Sensor Through Hole with a Display Size of 0.59 x 0.59 inches (15 x 15 mm) square









Applications

- Mobile communication devices
- Electronic devices
- Point of sale Terminals
- Gaming
- Industrial control displays

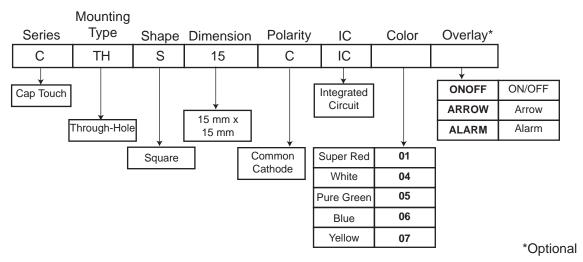
- Touch Screen Monitors
- Portable Instruments
- Media Players
- Medical devices
- Appliances and consumer equipments

Key Features

- Integrated touch sensing and display technology
- Enables the device interface to be more user friendly and intuitive
- Mounting type: through hole (industry standard pitch 0.100")
- Available in one standard size: 15.0mm x 15.00mm x 11.00mm
- Available in 5 colors: super red, white, pure green, blue or yellow
- Touch sensor: integrated circuit (IC)
- Uniform illumination and high optical clarity due to LED technology
- Robust design due to no mechanical moving parts
- Simplifies devices design and manufacturability
- Optional overlay (icons): on/off, arrow, alarm
- Custom overlay icon can be manufactured upon request contact VCC
- Compliant with RoHS and REACH requirements

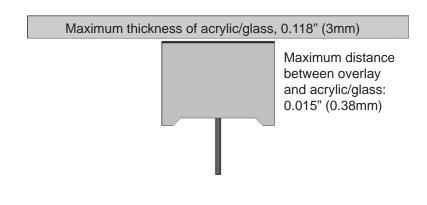
Ordering Data

The CTH Series (Cap Touch) is available in a range of standard features and options. To specify your Cap Touch Display, simply choose one option from each column.



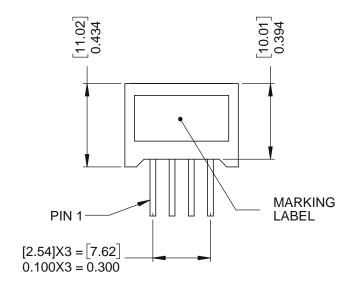
Overlay

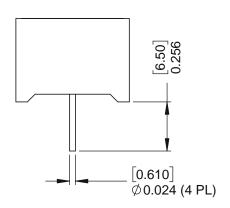
- Different LED colors can indicate the mode in which an electronic device is operating, depending on the icon associated with it.
- Optional graphic overlay made with polished LEXAN[™] Polycarbonate 8010 Film 0.007" (0.175 mm) thick has reverse printed translucent white icon, in order to still see it even when the back lighting is off.
- Lexan 8010 is a transparent polycarbonate film and offers hardness, chemical and abrasion resistance, stiffness, and high temperature capability.
- Three standard icons are available: alarm, arrow and on-off. Custom icons are also available upon request.
- Capacitive Touch Display can also be mounted behind clear glass or plastic layer such as polycarbonate or acrylic, as shown in the picture below.

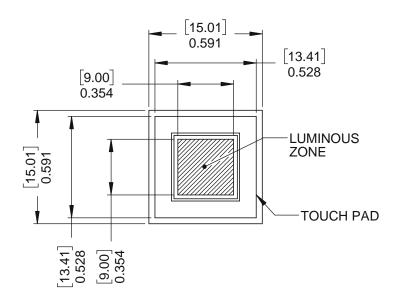


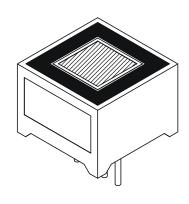
ம	Overlay On/Off
•	Overlay Arrow
Ŵ	Overlay Alarm

Package Dimensions

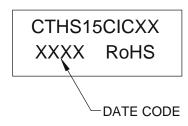








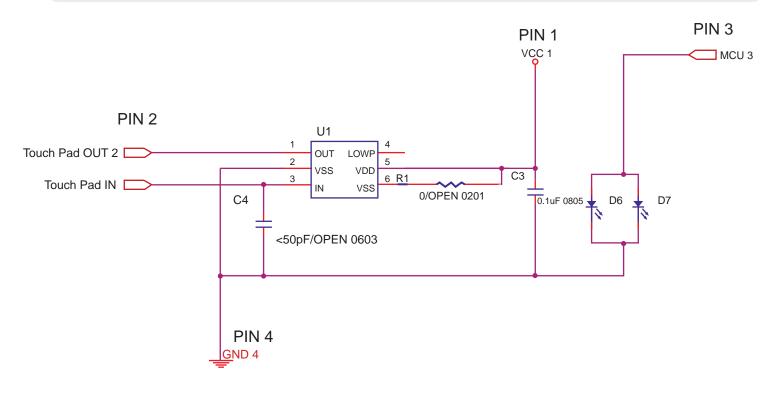
MARKING LABEL INFO



Dimensions in [mm] inches General tolerances unless otherwise specified:

	inches	mm
.X	± .020	±.508
.XX	±.010	±.254
.XXX	±.005	±.127

Internal Circuit Diagram



Internal IC Electrical Characteristics

(TA = 25°C, unless otherwise specified)

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units.
VDD	Supply Voltage		2.0		5.5	V
VIH	High Level Input Voltage	@ VDD = 5V	0.7VDD		VDD	V
VIL	Low Level Input Voltage	@ VDD = 5V			0.3VDD	V
IDD1 Operating Current	@ VDD = 5V , no load		16		μΑ	
peraumig comem		@ VDD = 3V , no load		3.5		μπ
IDD2 Operating Current		@ VDD = 5V , no load		10.5		μΑ
(SLRT=V	(SLRT=VDD)	@ VDD = 3V , no load		2.5		μ, τ
IOL	Low Level Output Current	@ VDD = 3V, VOL = 1V		30		mA
ЮН	High Level Output Current	@ VDD = 3V, VOL = 2V		8		mA

Product Specifications

ABSOLUTE MAXIMUM RATING FOR LED

(Ta=25°C)

Parameter	Symbol	Rating	Unit
		Yellow	
Power Dissipation Per Dice	PAD	70	mW
Derating Liner from 25°C per Dice	-	0.33	mA/°C
Continuous Forward Current Per Dice	IAF	25	mA
Peak Current Per Dice (duty cycle 1/10,1KHz)	IPF	90	mA
Reverse Voltage Per Dice	VR	5	V
Operating Temp.	Topr	-35 ~ +85	°C
Storage Temp.	Tstg	-35 ~ +85	°C

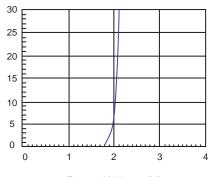
ELECTRO-OPTICAL CHARACTERISTICS

(Ta=25°C)

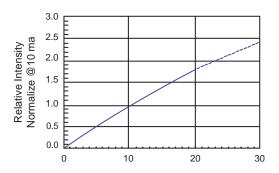
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	lv	113	220		mcd	IF = 20 mA
Forward Voltage	VF		2.1	2.8	V	IF = 20 mA
Peak Emission Wavelength	λР		592		nm	IF = 20 mA
Dominant Wavelength	λD		590		nm	IF = 20 mA
Spectrum Radiation Bandwidth	Δλ		20		nm	IF = 20 mA
Luminous Intensity Matching Ratio	І∨-м		-	2:1		IF = 10 mA
Reverse Current	lr		-	100	μΑ	Vr = 5V

ELECTRICAL/OPTICAL CHARACTERISTICES CURVES

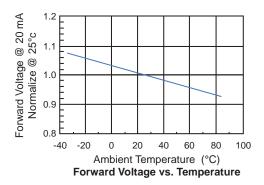
(Ta=25°C)

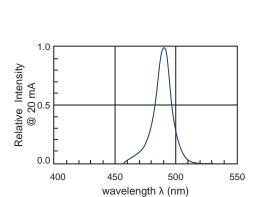


Forward Voltage (V)
Forward Current vs. Forward Voltage

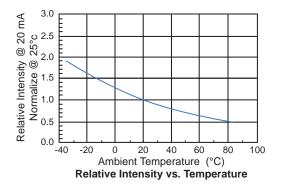


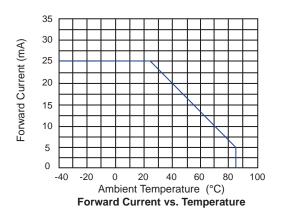
Forward Voltage (mA)
Relative Intensity vs. Forward Current





Relative Intensity vs. Wavelength





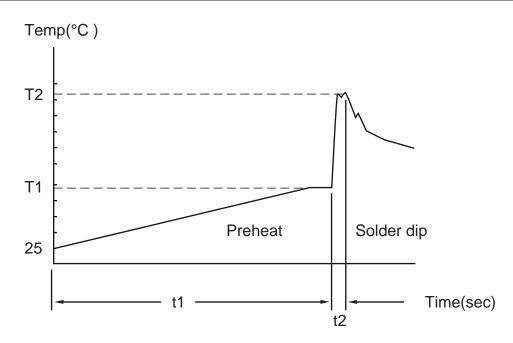
Product Specifications

SOLDERING CONDITIONS

1. Wave Soldering Profile

Distance: 1.6mm min (From Seating Plane)

Item	Condition		Note
Preheat	Temperature T1 80 – 120 °C		PWB Temperature
Freneat	Time t1	60 – 180sec	(Soldering Side Surface)
Solder Dip	Temperature T2	230 – 260°C	Bath Temperature
Solder Dip	Time t2	2 – 4 sec	Solder Tank Passage Time



2. Hand Soldering (Iron Condition)

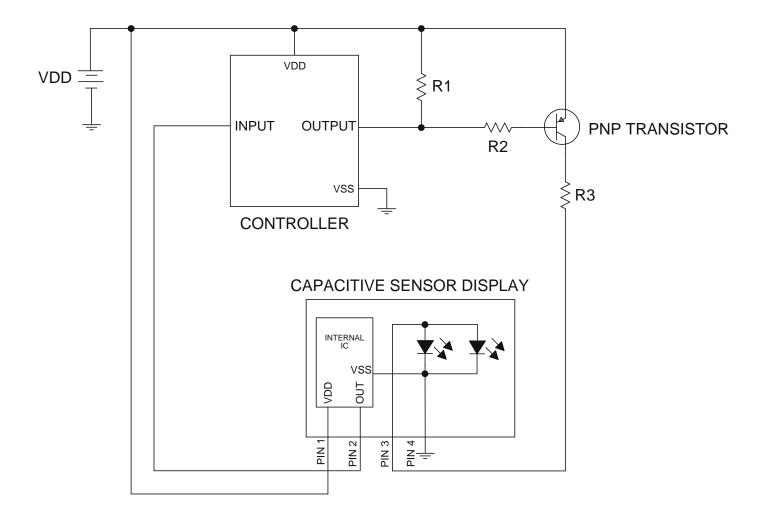
Soldering Iron: 30W Max

Temperature 350°C Max

Soldering Time: 3 Seconds Max (One Time)

Distance: 1.6mm min (From Seating Plane)

Application Circuit



Compliances and Approvals



